

Temperature Control of Diffusion/CVD Furnaces Using Robust Multivariable Loop-Shaping Techniques

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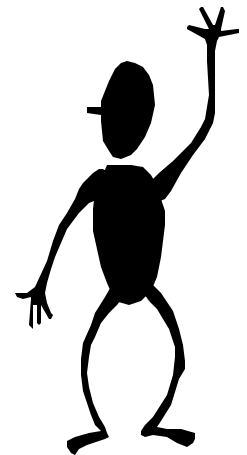
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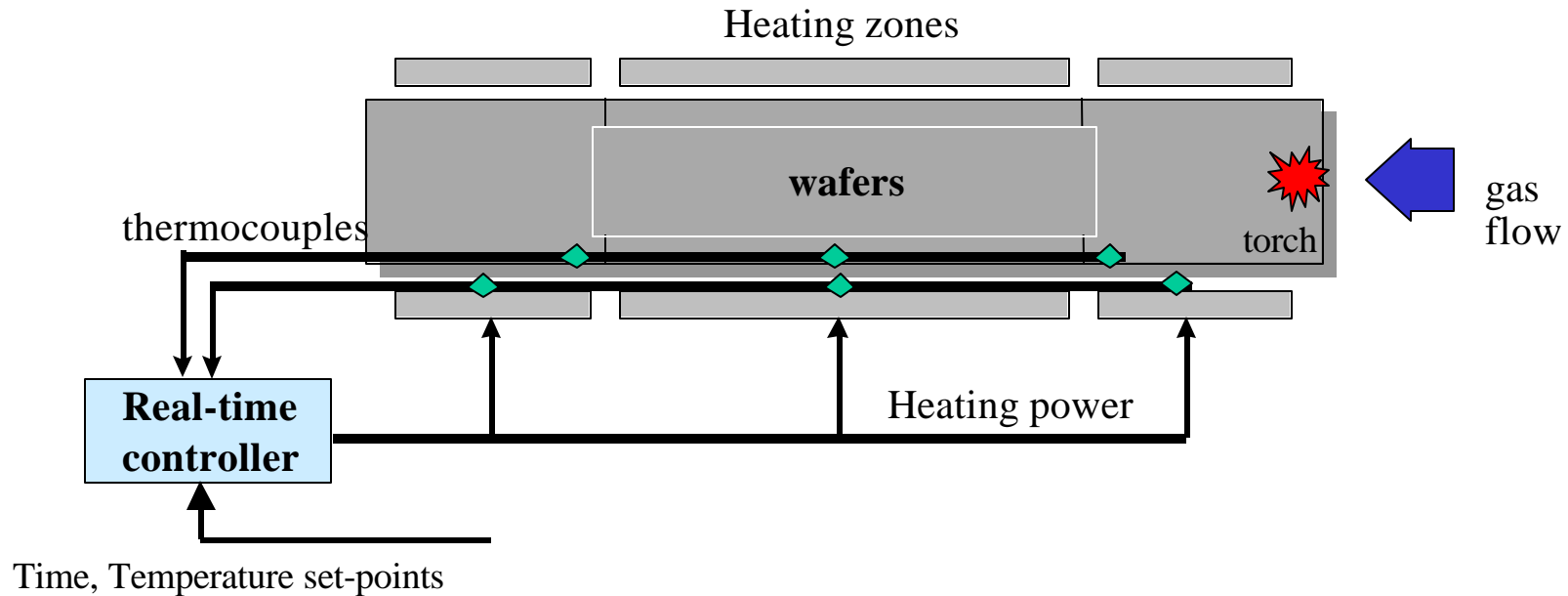
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- Issues:
 - Tight temperature control
 - Quick design turnaround (for retrofitting apps)

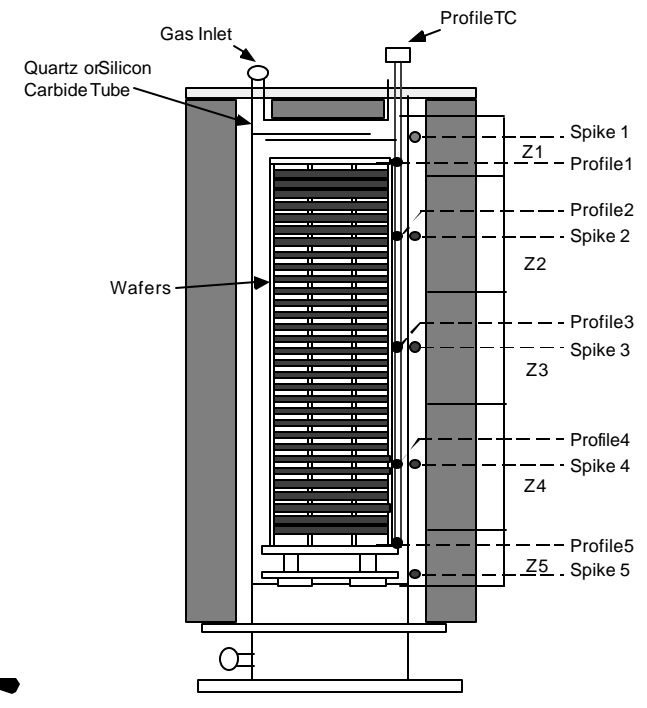
Introduction I



- Temperature uniformity, fast stabilization, disturbance attenuation,...
- Quick design, minimal iterations (furnace down-time)
- Low expertise requirements

Introduction II

- Standard Practice:
 - Spike PID, Profile table look-up
 - Periodic Profiling, Disturbances, Stabilization, Uniformity
- Model-based multivariable control
 - Modeling (nominal+uncertainty)
 - Controller design (loop-shaping)
 - Implementation
 - Multiple operating points



Modeling I

- System Identification
- Control-Oriented ID: Uncertainty description compatible with the controller design method.
 - Our choice: Loop-Shaping (available insight, computations) based on sensitivity and complementary sensitivity targets.
 - Nominal Model: MISO equation error, yielding a linear estimation model

$$y = N(\theta)[u] + D(\theta)[y] + e = w^T\theta$$

- Estimated parameters include initial conditions; this is important to handle short input-output sets that begin on a transient.
- Continuous time model.
- Regularization of estimates



CDC, December 1999

Modeling II

- **Coprime Factor Description of the Uncertainty**
- Robust Stability Condition: $\sigma [C S D^{-1}] \sigma [\Delta_N] + \sigma [S D^{-1}] \sigma [\Delta_D] < 1$
- CS~P⁻¹T: Relates uncertainty to target loop properties (controller independent).
- Uncertainty estimate + Target selection: Minimize RSC
- Effective closed loop uncertainty estimate: (for outer loop design)

$$\delta_{M,e} < \{ \sigma [S D^{-1}] \sigma [C S] \sigma [T^{-1}] \sigma [\Delta_N] + \sigma [S D^{-1}] \sigma [\Delta_D] \} \alpha$$

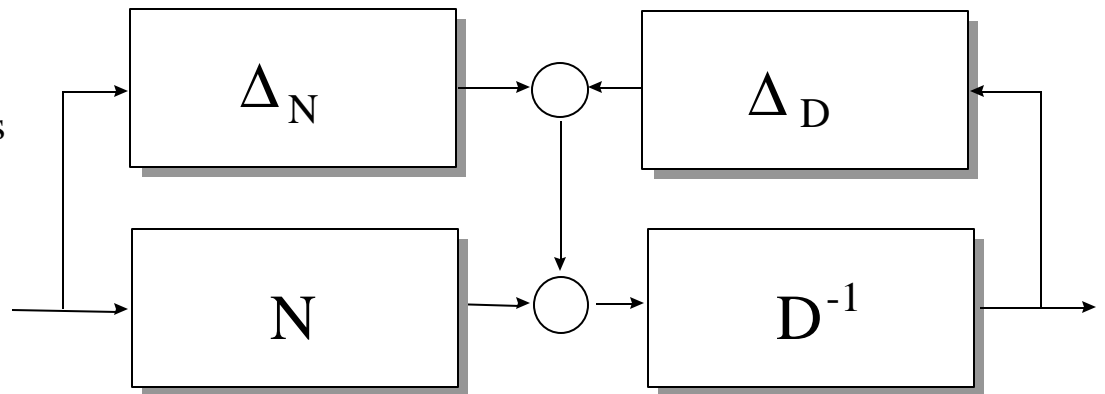
$$\alpha = (1 - \sigma [C S D^{-1}] \sigma [\Delta_N] + \sigma [S D^{-1}] \sigma [\Delta_D])^{-1}$$



Interpretation:

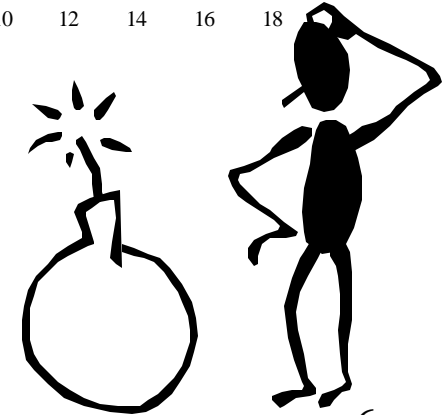
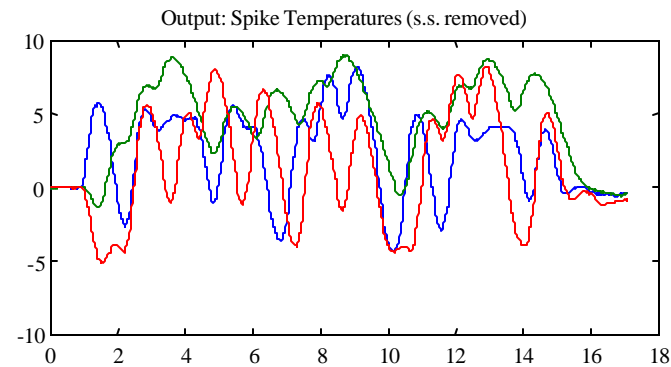
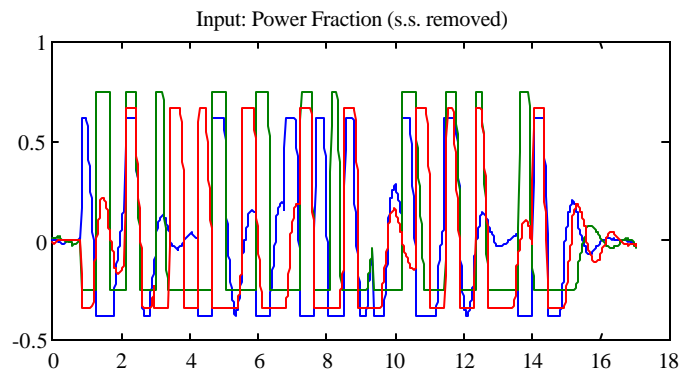
$\Delta_N \Rightarrow$ compl. sensitivity constraints
(high frequencies)

$\Delta_D \Rightarrow$ sensitivity constraints
(low frequencies)



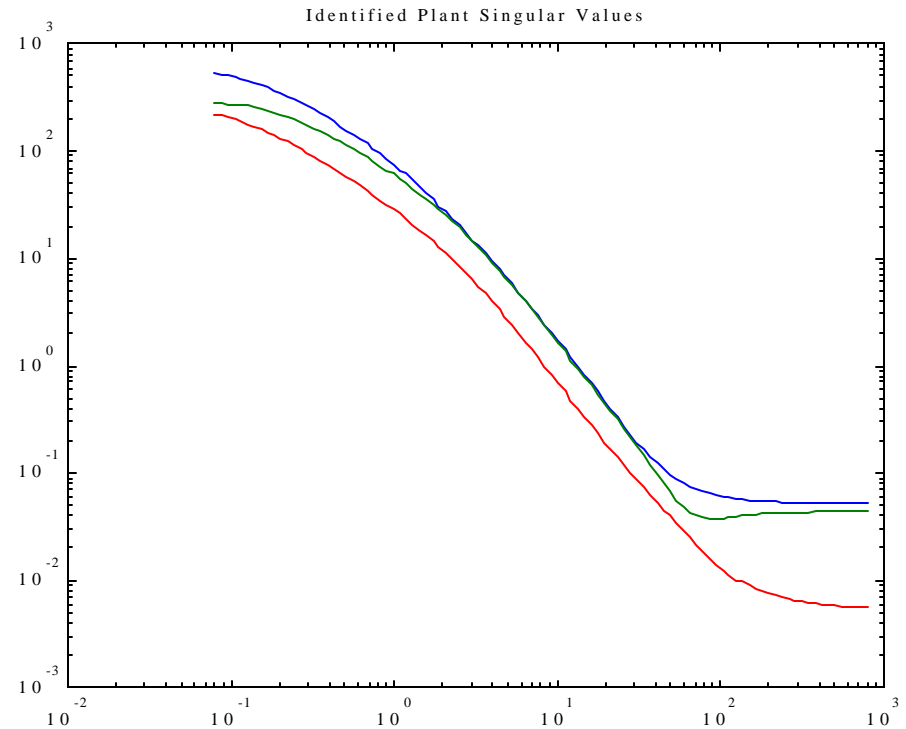
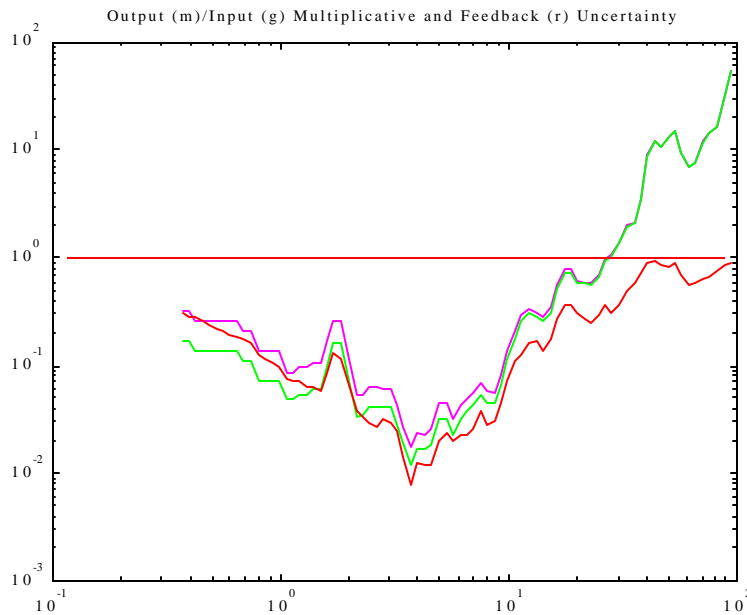
Modeling III

- Identification Experiment:
 - ~20 min test (net time at the operating conditions)
 - Target bandwidth ~5 rad/min



Inner Loop (Spike Subsystem) Modeling

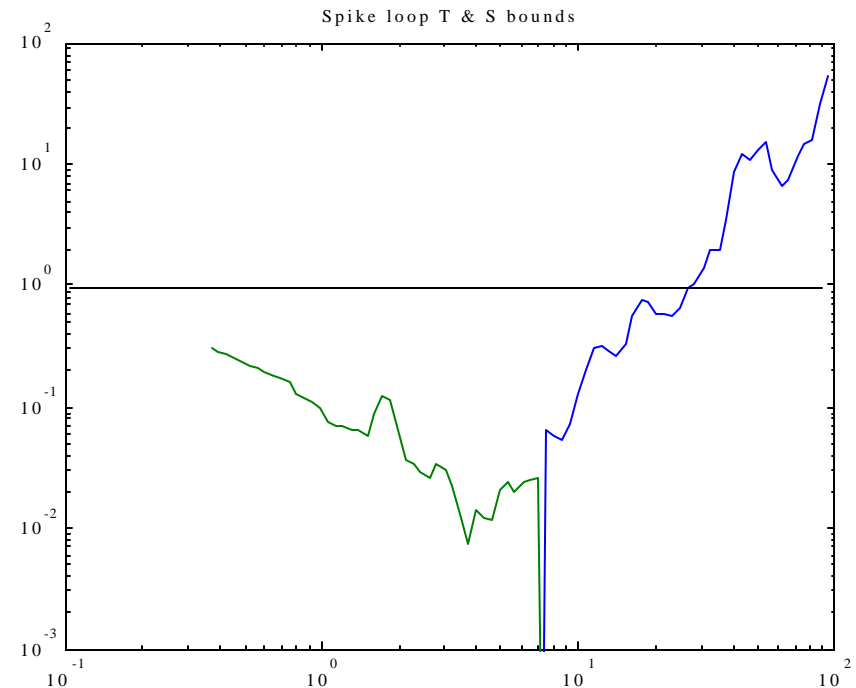
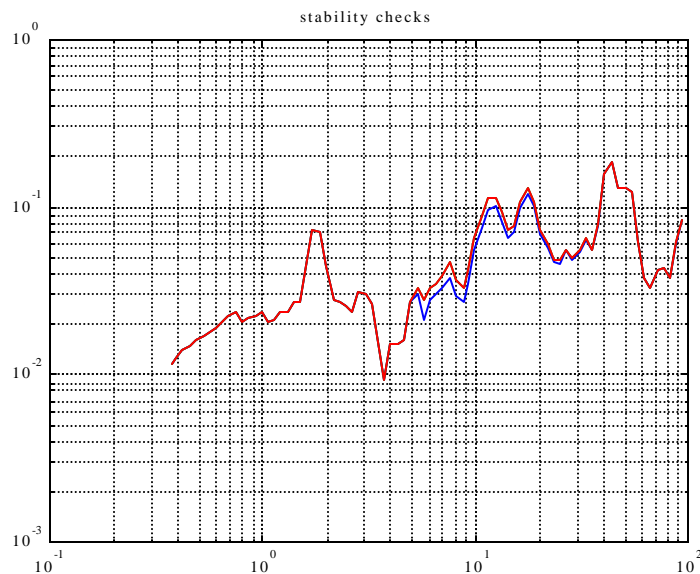
- Power to spike temperature. Very high and uncertain low frequency gain. (but good model around the intended crossover)



- “Raw” uncertainty data expressed as inverse S&T bounds ($|\text{fft}(e)|/|\text{fft}(u)|$, $|\text{fft}(e)|/|\text{fft}(y)|$) show asymptotic behavior.

Spike Model Uncertainty

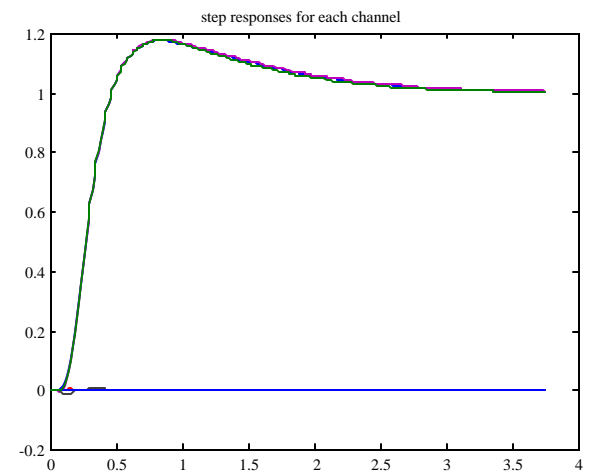
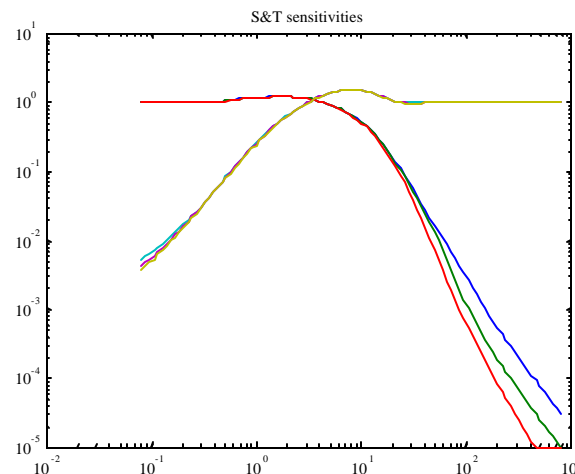
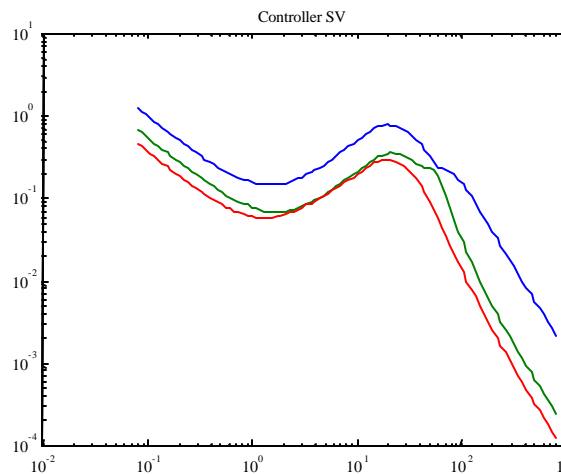
- After the split, the high frequency uncertainty is expressed as an inverse T constraint and the low frequency as an inverse S constraint.



- Rare limitations from RHP zeros
- Small RSC => Confidence in the design

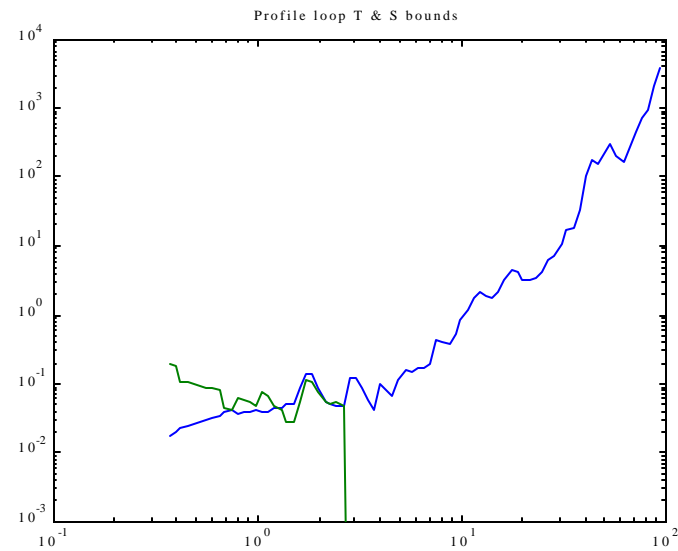
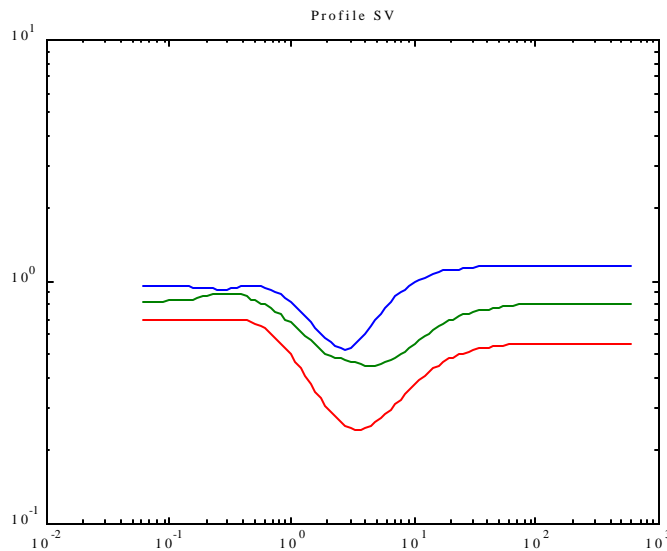
Spike Controller Design

- Target loop => weighted H-infinity sensitivity optimization
- The approach yields excellent matching properties with minimal iterations in the weight selection.
- Simple weights => Automation, Low expertise requirements.



Outer Loop (Profile Subsystem)

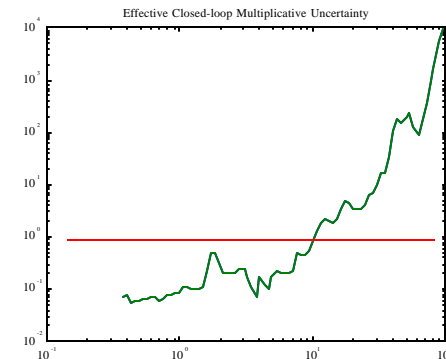
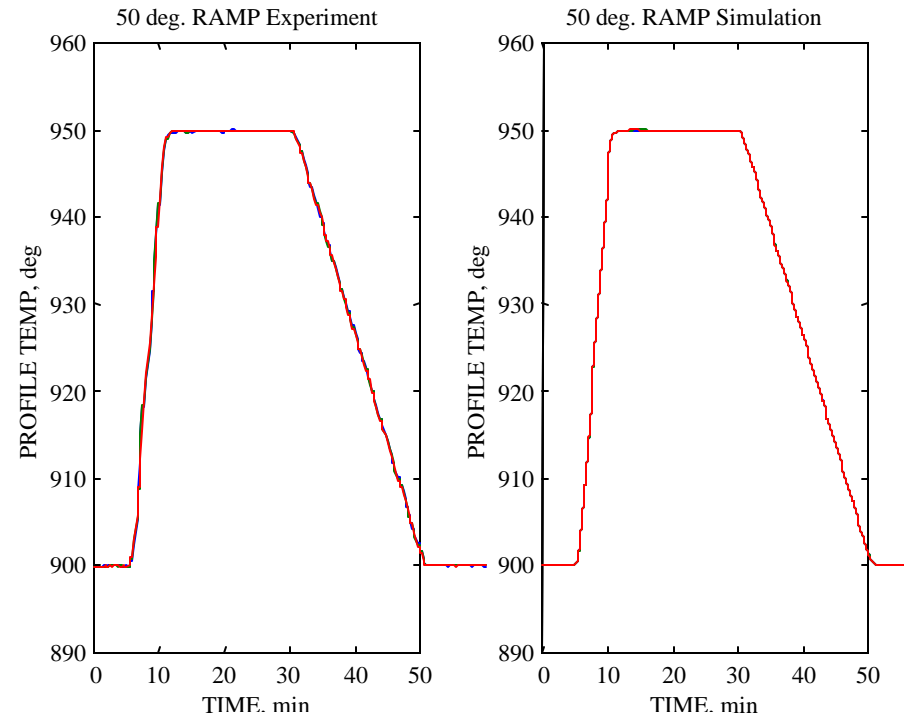
- The profile subsystem (spike to profile temperatures) is identified in a similar manner.
- Target loop constraints: profile subsystem uncertainty, nominal inner closed-loop, effective inner closed-loop uncertainty.
- The profile controller is designed for the combined profile/inner-loop system. Typically a straightforward design.



Controller Implementation and Testing



- After reduction, the controller is discretized and augmented with anti-windup mechanisms.
- Excellent and predictable performance in the typical ramp-up/ramp-down operations



More Results

- “Temperature no longer variable of concern”

Source: M. Yelverton, et. al. , AEC/APC XI, 1999. (AMD)

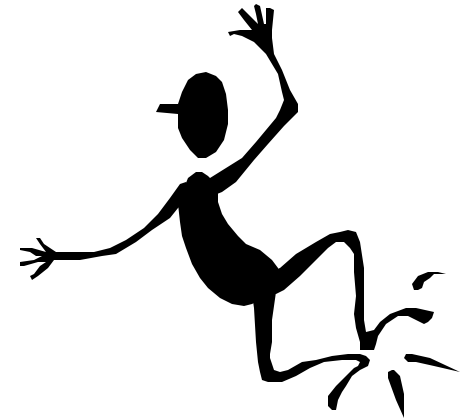
- Process Results:

- Decreased cycle time (faster controlled ramps, faster stabilization). Time-to-process reduced by as much as 50%
- Increased process indices (C_p , C_{pk} by as much as 250%)
- Increased tool utilization (no need for profiling)

Source: Tucker, Valdez, Tsakalis, Warren and Stoddard, AEC/APC X, 1988. (Motorola, Mesa)

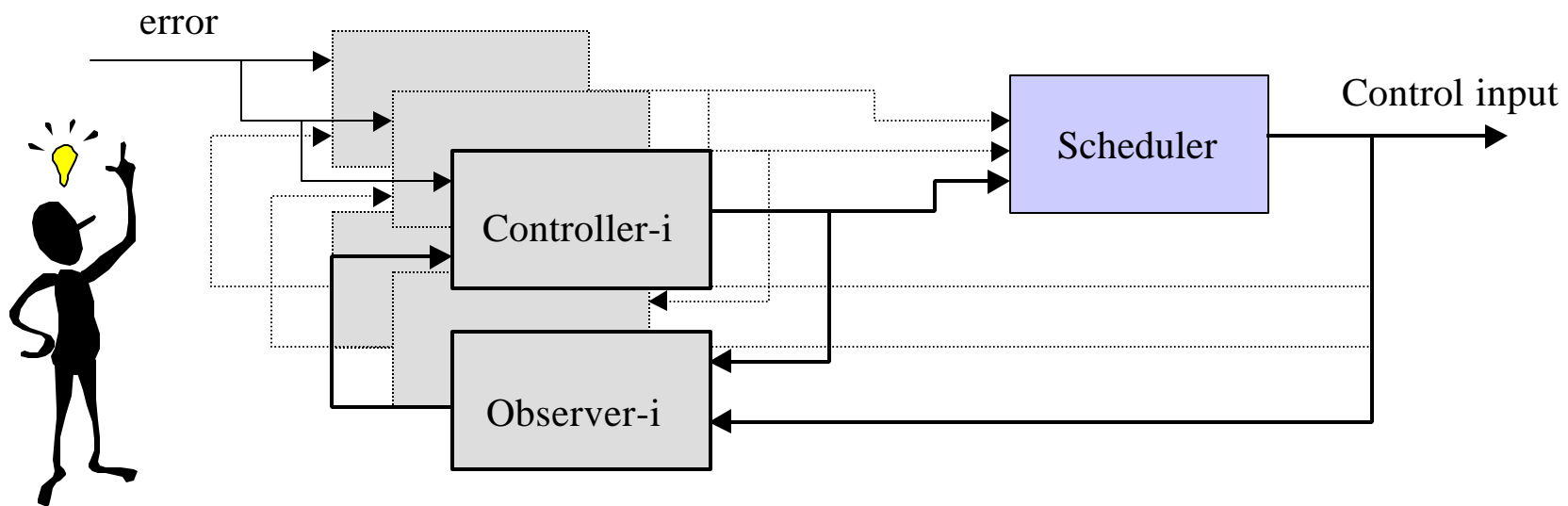
- >300 controllers in operation

- Semiconductor Intl, Best Product Award, 1988

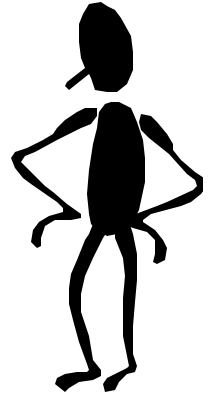


Controller Scheduling

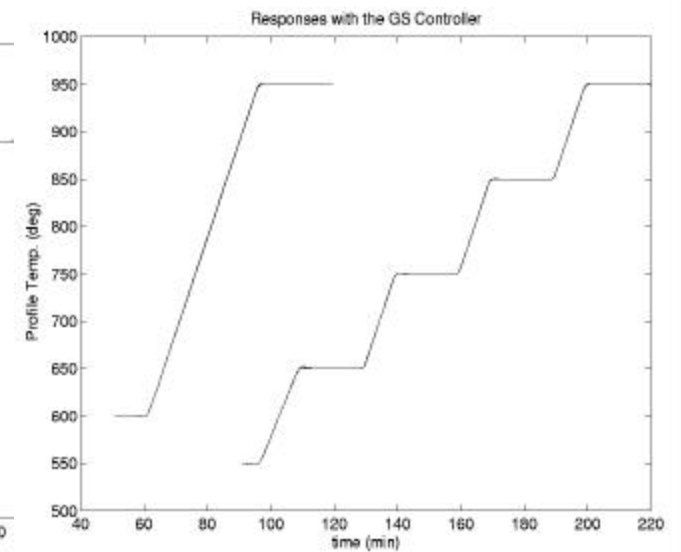
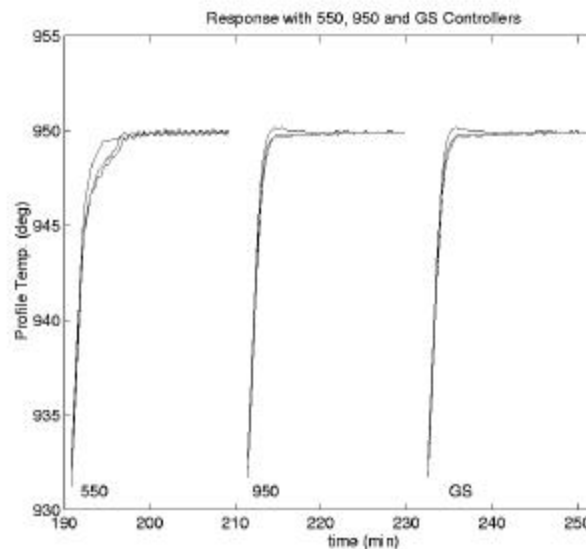
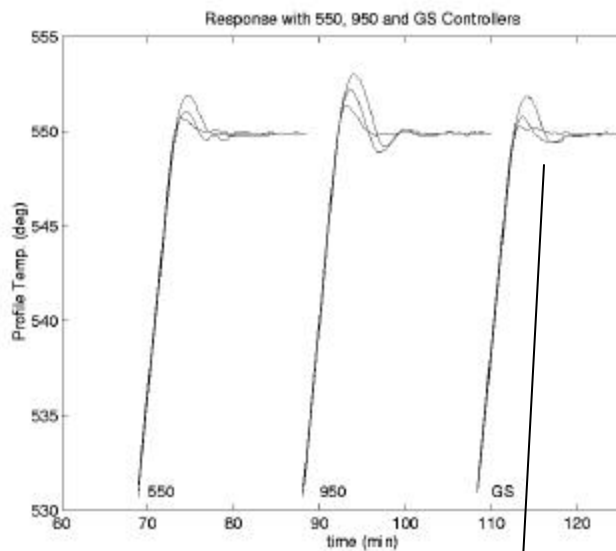
- Handling multiple operating conditions
- Modeling and controller design at different steady-states
- Scheduling with bumpless transfer techniques
 - In general, models and controllers will have different order; simple interpolation is not enough.



Scheduled Controller Tests



- Higher -but manageable- complexity
 - 3 controllers covering the range 500-1000 deg.C
- Scheduled controller has good performance in the entire range and transfers are fairly smooth



Overshoot due to saturation

Concluding Remarks

- Integrated method to design high-performance temperature controllers
- Quick and reliable designs; low expertise requirements
- Excellent success record
- Controller scheduling to handle wide-range operations
- Future work:
 - Tech-transfer to other processes
 - Nonlinear modeling and uncertainty descriptions

